OF	70 d.
01.0.2	U.S. DEPARTMENT OF COMMERCE FTER Patent and Trademark Office
101	949098 Attorney Docket No.: 211A 3128 record the attached original documents or copy thereof.
	record the attached original documents of copy thereor.
Name of conveying party(ies):	Name and address of receiving party(ies):
ISAMU KANEKO TOMOHIRO SAITO	ENPLAS CORPORATION 30-1, Namiki 2-chome, Kawaguchi-shi, Saitama 332-0034, Japan
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	
3. Nature of conveyance:	
☐ Security Agreement ☐ Change of Name	
Other	
Execution Date: September 12, 2001	Additional name(s) & address(es) attached? ☐ Yes ☒ No
<ol> <li>Application number(s) or patent number(s):</li> <li>If this document is being filed together with a new application, the ex</li> <li>A. Patent Application No.(s) 09/876,302</li> </ol>	B. Patent No.(s)
Additional numbers a	ttached? ☐ Yes ☒ No
<ol><li>Name and address of party to whom correspondence concerning document should be mailed:</li></ol>	6. Total number of applications and patents involved: [ 1 ]
William L. Androlia KODA & ANDROLIA	7. Total fee (37 CFR 3.41) \$40
2029 Century Park East, Suite 3850 Los Angeles, CA 90067-3024	<ul> <li>☑ Enclosed</li> <li>☐ Authorized to be charged to deposit account</li> </ul>
	8. Deposit account number:
	11-1445
	(Attach duplicate copy of this page if paying by deposit account)
DO NOT L	JSE THIS SPACE
9. Statement and signature.	
To the best of my knowledge and belief, the foregoing is true and c	correct and any attached copy is a true copy of the original document.
William L. Androlia, Reg. No. 27,177	Date: October 5, 2001
OMB No. 0651-0011 (exp. 4/94)	
Mail documents to be recorded with required cover sheet	information to:

Assistant Commissioner for Patents Box Assignments Washington, D.C. 20231

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PATENT REEL: 12456 FRAME: 0915

## **ASSIGNMENT**

(1) ISAMU KANEKO (5) (2) TOMOHIRO SAITO (6) (3) (7) (4) (8) In consideration of the sum of one dollar (\$1.00) and other good and value considerations paid to each of the undersigned, the undersigned agree(assign, and hereby does assign, transfer and set over to (9) Insert name of Assignee (9) ENPLAS CORPORATION (10) Insert state of Incorporation of Assignee (11) Insert address of Assignee (11) Insert address of Assignee (11) Insert identification of Invention, such as Title, Case Number or Foreign Application Number (12) Insert Date of Signing of Application (13) Insert Date of Signing of Application (13) Insert Date of Signing of Application (13) Insert Date of Signing of Application (14) Insert Date of Signing of Application (15) Insert Date of Signing of Application (16) Insert Date of Signing of Application (17) Insert Date of Signing of Application (18) Insert Date of Signing of Application (19) Insert Date of Signing of Insert Date of Signing of Application (19) Insert Date of Signing of Insert Date	(s) to
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In consideration of the sum of one dollar (\$1.00) and other good and value considerations paid to each of the undersigned, the undersigned agree (assign, and hereby does assign, transfer and set over to  (9) Insert name of Assignee (10) Insert state of Incorporation of Assignee (11) Insert address of Assignee (11) Insert address of Assignee (11) of 30-1, Namiki 2-chome, Kawaguchi-shi, Saitama 332-0034, Japan (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as (12) Insert identification of Invention, such as Title, Case Number or Foreign Application Number (12) Insert Date of Signing of Application (13) Insert Date of Signing of Application (14) Insert Date of Signing of Application (15) Insert Date of Signing of Application (16) ENPLAS CORPORATION (17) Japan (18) Mage PICKUP LENS SYSTEM (Application Serial No. 09/876,302) for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.	(s) to
<ul> <li>(10) Insert state of Incorporation of Assignee</li> <li>(11) Insert address of Assignee</li> <li>(11) Insert identification of Invention, such as Title, Case Number or Foreign Application Number</li> <li>(12) Insert Date of Signing of Application</li> <li>(13) Insert Date of Signing of Application</li> <li>(14) Insert state of Incorporation of Invention of Invention (10) Japan</li> <li>(15) Japan (10) Japan (10) Serial No. 10, 10, 10, 10, 10, 10, 10, 10, 10, 10,</li></ul>	
<ul> <li>(11) Insert address of Assignee</li> <li>(11) Insert address of Assignee</li> <li>(12) Insert identification of Invention, such as Title, Case Number or Foreign Application Number</li> <li>(13) Insert Date of Signing of Application</li> <li>(14) Insert Date of Signing of Application</li> <li>(15) Insert Date of Signing of Application</li> <li>(16) Insert Date of Signing of Application</li> <li>(17) Insert Date of Signing of Application</li> <li>(18) Insert Date of Signing of Application</li> <li>(19) Insert Date of Signing of Application</li> <li>(11) of 30-1, Namiki 2-chome, Kawaguchi-shi, Saitama 332-0034, Japan (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(19) Insert Date designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as</li> <li>(12) Insert identification of Invention, (hereinafter designated as the Assignee) the entire worldwide ri</li></ul>	
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such as Title, Case Number or Foreign Application Number for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.  (13) Insert Date of Signing of Application (13) on 12 September 2001	the
Application	
1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, division and continuing United States and foreign applications for the above-identified invention and also to execute separassignments in connection with such applications as the Assignee may deem necessary or expedient.	
2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every possible in obtaining evidence and going forward with such interference.	
3) The undersigned agree(s) to execute all papers and documents and perform any act which may necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or sin agreements.	
4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a vulnited States patent to the Assignee.	/alid
5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and Letters Patents of the United States resulting from said application or any division or divisions or continuing application thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.	ions
6) The undersigned hereby appoints WILLIAM L. ANDROLIA, Reg. No. 27,177 and H. HENRY KODA, Reg. 27,729 the power to insert on this assignment any further identification which may be necessary or desirable in order comply with the rules of the United States Patent and Trademark Office for recordation of this document.	
Date: September 12, 200/ Signature of Inventor Dsamu Kaneko	
Date: September 12, 200   Signature of Inventor TOMOHIRO SAITO	
Date: Signature of Inventor	
Date: Signature of Inventor	
This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A.; (b) a U.S. Consul if outside th U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:	ı <b>e</b>
Date: Witness	

Witness\_\_\_\_

Date: \_\_\_\_\_

**RECORDED: 01/09/2002** 

PATENT REEL: 12456 FRAME: 0916